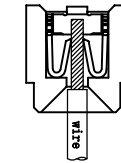
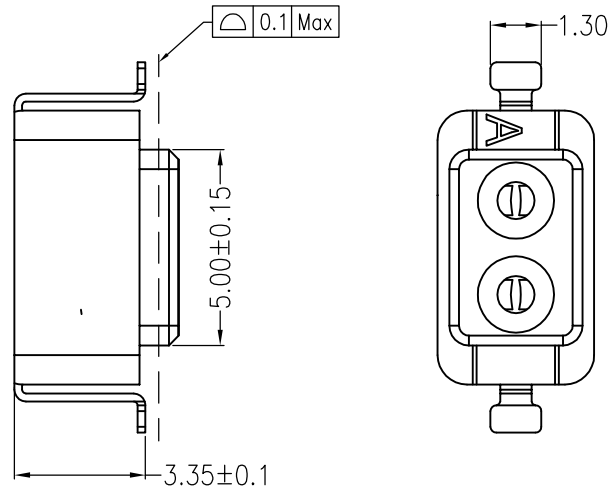
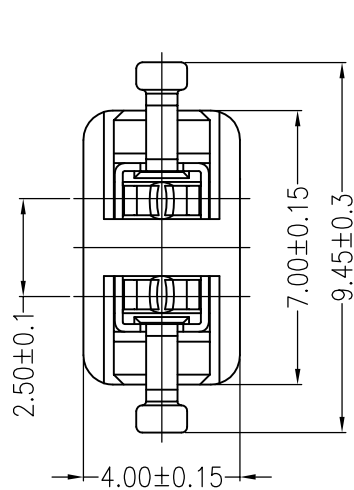
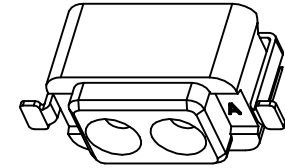


REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	曾令青	2019.04.03



Assembly Layout



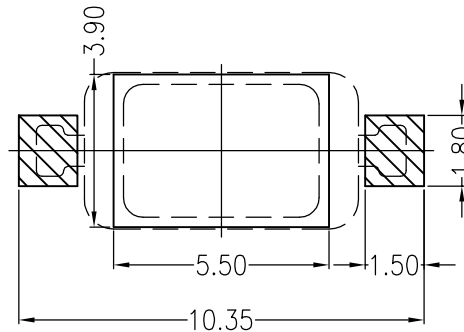
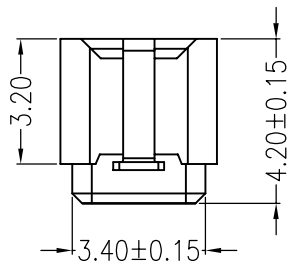
主要技术参数 Main Specifications

线 数 (Poles): 02
 接触电阻 (Contact resistance): $\leq 20m\Omega$
 绝缘电阻 (Insulation resistance): $\geq 1000M\Omega$
 额定电压 (Rated voltage): 275V AC DC
 额定电流 (Rated current): 1.0A AC DC
 耐 电 压 (Withstand Voltage): 1500V AC/minute
 温度范围 (Temperature Range): $-40^{\circ}C \sim +120^{\circ}C$

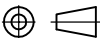
ORDER INFORMATION:

L2503AFV-02-F2MB1-R

PART No. _____
 No. FOR CIRCUITS: _____
 02
 PLASTIC MATERIAL: _____
 F2M=LCP (BEIGE)
 PLATING: _____
 B=MATTE Sn
 PACKAGING: _____
 R=REEL
 P=PE
 Metal code: _____
 1=Phosphor bronze



Board Layout
General Tolerance: ± 0.05

C				
B	CONTACT		2 PCS	Phosphor bronze TIN-plated
A	PEDESTAL		1 PCS	LCP UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT		Q'TY	MATERIAL FINISH
 东莞市高迪电子有限公司 DONG GUAN GAO DI ELECTRONICS CO., LTD				TITLE: 2.5mmPITCH 180°WAFER SMT TYPE
X.±0.5		X.±5'	USE: CUSTOMER	PART NO.: L2503AFV-02-F2MB1-R
.X±0.3		.X±2'	APPD: 邵敬和	DWG NO.: GCKH-1382
.XX±0.25		.XX±1'	CHKD: 曾令青	
--		--	DR: 蒋建银	SCALE 1 : 1
		UNITS: mm		SHEET 1 / 1